



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of Tong	Attorney Docket # 1988.EEM
Serial No. 10/084,869	Examiner: David E. Aylward
Filing Date: March 1, 2002	Group Art Unit: 1712
Title: Underfill Encapsulant for Wafer Packaging and Method for its Application	Date of this response: July 18, 2003

Assistant Commissioner of Patents
Washington, DC 20231

RESPONSE

Dear Sir,

This is in response to paper number 7 mailed May 13, 2003. Claims 1 - 31 are pending in the application. Claims 1 and 3 are rejected, claims 4 – 24 and 26 – 31 are objected to and claim 25 is allowed.

Kindly amend the claims as set out below.

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